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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/575,365	04/11/2006	Munetaka Watanabe	Q78082	9055
23373 7590 02/03/2009 SUGHRUE MION, PLLC 2100 PENNSYLVANIA AVENUE, N.W. SUITE 800 WASHINGTON, DC 20037				
EXAMINER HSIEH, HSIN YI				
ART UNIT 2811		PAPER NUMBER		
MAIL DATE 02/03/2009		DELIVERY MODE PAPER		

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Interview Summary

Application No.

10/575,365

Applicant(s)

WATANABE, MUNETAKA

Examiner

Hsin-Yi (Steven) Hsieh

Art Unit

2811

All participants (applicant, applicant's representative, PTO personnel):

(1) Hsin-Yi (Steven) Hsieh.(3) Yan Lan.(2) Lynne Gurley.

(4) ____.

Date of Interview: 22 January 2009.

Type: a) ☒ Telephonic b) ☐ Video Conference
c) ☐ Personal (copy given to: 1) ☐ applicant 2) ☐ applicant's representative]

Exhibit shown or demonstration conducted: d) ☐ Yes e) ☒ No.

If Yes, brief description: ____.

Claim(s) discussed: 1.

Identification of prior art discussed: Kamimura et al.

Agreement with respect to the claims f) ☐ was reached. g) ☒ was not reached. h) ☐ N/A.

Substance of Interview including description of the general nature of what was agreed to if an agreement was reached, or any other comments: The limitation "the bonding pad layer is provided atop a portion less than the entirety of the ohmic electrode layer" of claim 1 was discussed. The examiner suggested language to clarify the position of the portion, for example "the bonding pad layer is provided atop a portion of the ohmic electrode layer, said portion is less than the entirety of the ohmic electrode layer". The attorney stated that examiner's comment will be taken into consideration.

(A fuller description, if necessary, and a copy of the amendments which the examiner agreed would render the claims allowable, if available, must be attached. Also, where no copy of the amendments that would render the claims allowable is available, a summary thereof must be attached.)

THE FORMAL WRITTEN REPLY TO THE LAST OFFICE ACTION MUST INCLUDE THE SUBSTANCE OF THE INTERVIEW. (See MPEP Section 713.04). If a reply to the last Office action has already been filed, APPLICANT IS GIVEN A NON-EXTENDABLE PERIOD OF THE LONGER OF ONE MONTH OR THIRTY DAYS FROM THIS INTERVIEW DATE, OR THE MAILING DATE OF THIS INTERVIEW SUMMARY FORM, WHICHEVER IS LATER, TO FILE A STATEMENT OF THE SUBSTANCE OF THE INTERVIEW. See Summary of Record of Interview requirements on reverse side or on attached sheet.

/Hsin-Yi (Steven) Hsieh/
Examiner, Art Unit 2811

/Lynne A. Gurley/
Supervisory Patent Examiner, Art Unit 2811